EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S41	146	caulk$3 and gasket and (chip or die) and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 14:39
S42	1187	caulk$3 and (chip or die) and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 13:54
S43	802	gasket same (top or cover or lid or cap) and (chip or die) and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 14:42
S44	2	("20050212117").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/08/08 18:20
S45	33	("20020067663" | "20040032705" | "4533795" | "4628740" | "4776019" | "4825335" | "4908805" | "4910840" | "5146435" | "5151763" | "5178015" | "5357807" | "5408731" | "5449909" | "5452268" | "5490220" | "5506919" | "5531787" | "5592391" | "5593926" | "5740261" | "5748758" | "5831262" | "5870482" | "5923995" | "5939968" | "6012335" | "6078245" | "6108184" | "6191928" | "6282072").PN. OR ("6781231").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 15:00
S46	6	("4736128" | "5608362" | "5920242" | "5939956" | "6157076").PN. OR ("6794958").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 15:02
S47	5	("4684763" | "5270571" | "5821175" | "6168947" | "6281573").PN. OR ("6836013").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 15:02
S48	4	("4684763" | "5270571" | "6168948" | "6281573").PN. OR ("6919222").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 15:19
S49	424	hermetic$4 and seal$4 and (bond$4 or adhe$4) and substrate and semiconductor and gasket	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 15:51
S50	2	("6118181").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/08/08 15:25

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S51	2	("6090687").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/08/08 15:26
S52	13	("20010017516" | "20020074938" | "20030045016" | "20030094591" | "20030143423" | "20030209979" | "20030214232" | "6210815" | "6307218" | "6548912" | "6624572" | "6656828" | "6661029").PN. OR ("7026660").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 15:34
S53	8463	hermetic$4 and seal$4 and (bond$4 or adhe$4) and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 15:57
S54	1819	gasket near5 seal$4 and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 15:57
S55	13	("20010017516" | "20020074938" | "20030045016" | "20030094591" | "20030143423" | "20030209979" | "20030214232" | "6210815" | "6307218" | "6548912" | "6624572" | "6656828" | "6661029").PN. OR ("7026660").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/08 16:08
S56	0	"20050212117".pn. and (open adj space or separated)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 18:46
S57	1	"20040211966".pn. and hermetic$4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 18:52
S58	1	"20030143423".pn. and hermetic$4	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/08 18:52

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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3	"20040211966"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:25
L2	4	"20030143423"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:25
L3	7	"6787897"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:26
L4	4	"6459160"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:26
L5	8	"6046074"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:26
L6	1360	257/704.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:33
L7	497	257/710.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:38
L8	665	257/781.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/08/12 19:38